



曜凌光電股份有限公司

住址: 42878 台中市大雅区科雅路 25 號 5F WEB: <http://www.Raystar-Optronics.com>
5F., No.25, Keya Rd., Daya Dist., Taichung E-mail: sales@raystar-optronics.com
City 428, Taiwan Tel:886-4-2565-0761 Fax : 886-4-2565-0760

RG320240A1-YHY-M

SPECIFICATION

CUSTOMER:

APPROVED BY	
PCB VERSION	
DATE	

FOR CUSTOMER USE ONLY

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

ISSUED DATE:

Contents

	Page
1. Specification Revision History	3
2. General Specification	4
3. Module Classification Information	5
4. Interface Pin Function	6
5. Outline dimension & Block Diagram	7
6. Timing Characteristics	8
7. Optical Characteristics	11
8. Absolute Maximum Ratings	12
9. Electrical Characteristics	12
10. Backlight Information	13
11. Reliability	14
12. Inspection specification	15
13. Precautions in use of LCD Modules	19
14. Material List of Components for RoHs	20
15. Recommendable storage	20

1. Revision History

DATE	VERSION	REVISED PAGE NO.	Note
2014/3/3	1		First issue

2. General Specification

The Features of the Module is description as follow:

- Module dimension: 160.0 x 109.0 x 13.0 (max.) mm
- View area: 122.0 x 92.0 mm
- Active area: 115.18 x 86.38 mm
- Number of Dots: 320 x2 40
- Dot size: 0.34 x 0.34 mm
- Dot pitch: 0.36 x 0.36 mm
- LCD type: STN Positive, Yellow Green Transflective
- View direction: 6 o'clock
- Backlight Type: LED Yellow Green

3. Module Coding System

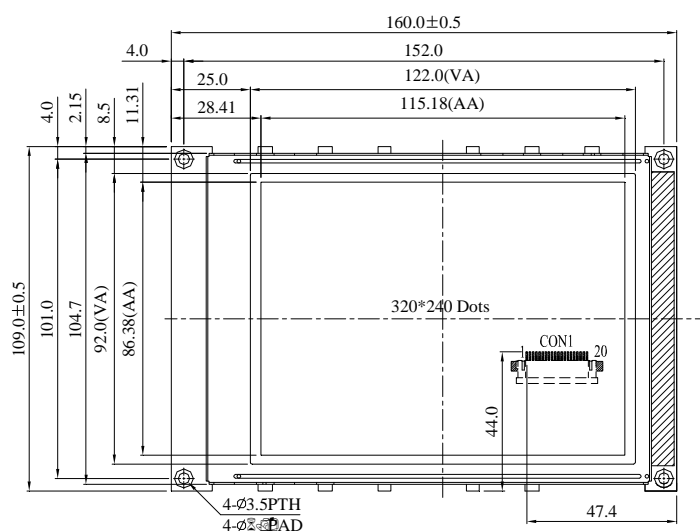
R	G	320240	A1	-	Y	H	Y	-	M
1	2	3	4	-	5	6	7	-	8

Item	Description	
1	R : Raystar Optronics Inc.	
2	Display	C : Character Type, G : Graphic Type
3	Number of dots : 320 x240 Dots	
4	Serials code	
5	LCD	P : TN Positive, Gray N : TN Negative, G : STN Positive, Gray Y : STN Positive, Yellow Green B : STN Negative, Blue F : FSTN Positive T : FSTN Negative
6	Polarizer Type, Temperature range, View direction	A : Reflective, N.T, 6:00 K : Transflective, W.T,12:00 D : Reflective, N.T, 12:00 1 : Transflective, U.T,6:00 G : Reflective, W. T, 6:00 4 : Transflective, U.T.12:00 J : Reflective, W. T, 12:00 C : Transmissive, N.T,6:00 O : Reflective, U. T, 6:00 F : Transmissive, N.T,12:00 3 : Reflective, U. T, 12:00 I : Transmissive, W. T, 6:00 B : Transflective, N.T,6:00 L : Transmissive, W.T,12:00 E : Transflective, N.T.12:00 2 : Transmissive, U. T, 6:00 H: Transflective, W.T,6:00 5 : Transmissive, U.T,12:00
7	Backlight	N : Without backlight Y : LED, Yellow Green P : EL, Blue green A : LED, Amber T : EL, Green W : LED, White D : EL, White O : LED, Orange F : CCFL, White B : LED, Blue
8	Special code	M: Build in Negative Voltage & Temperature Compensation

4. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V_{SS}	0V	Ground
2	V_{DD}	5.0V	Power supply for Logic
3	V_O	(Variable)	Driving voltage for LCD
4	A0	H/L	RD=L WR=H ,A0=L :Data Read AO=H :Status read RD=H WR=L ,A0=L :Data Write AO=H :Command write
5	\overline{WR}	H/L	8080 family: Write signal, 6800 family: R/W signal
6	\overline{RD}	H/L	8080 family: Read signal, 6800 family: Enable clock
7~14	DB0~DB7	H/L	Data bus line
15	\overline{CS}	H/L	Chip select ,Active L
16	\overline{RES}	H/L	Controller reset signal, Active L
17	V_{EE}		Negative voltage output
18	SEL		8088,6800 interface selection (1:68 ,0:80)
19	FG		Frame Ground
20	NC		No connection

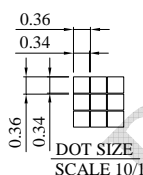
5. Outline Dimension & Block Diagram



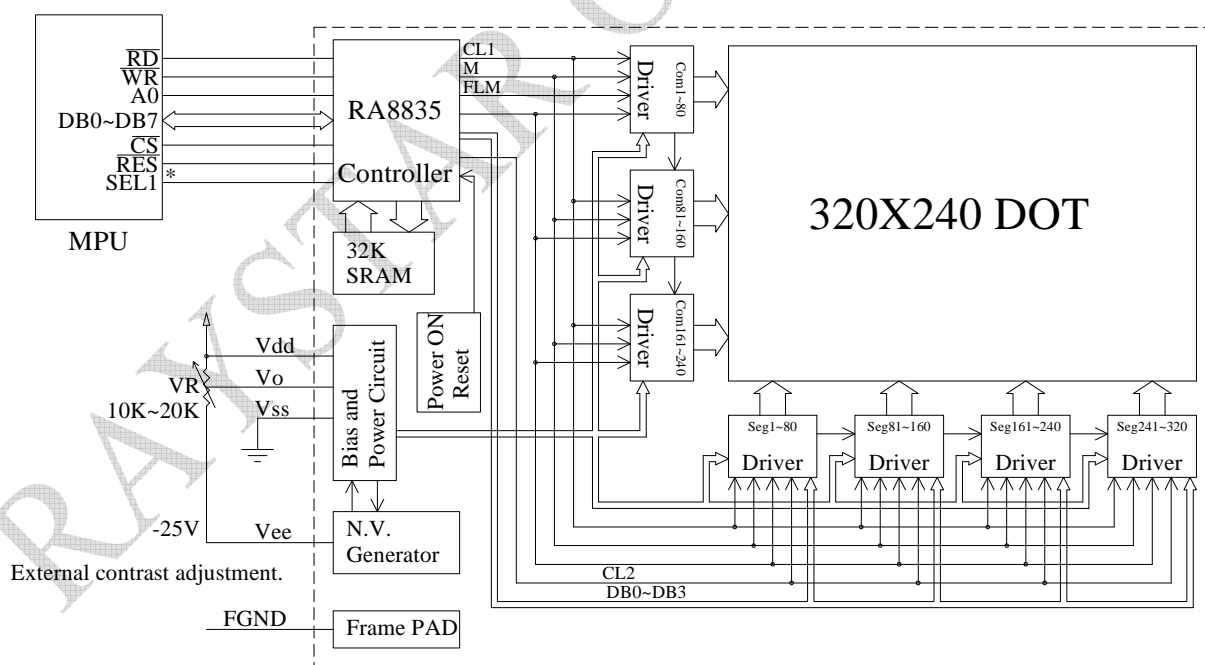
CN-FPC-20P/P1.0
(UP-Side)

1.0
(PCB)
LED B/L

PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	A0
5	WR
6	RD
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	CS
16	RES
17	Vee
18	SEL
19	FG
20	NC



The non-specified tolerance of dimension is $\pm 0.3\text{mm}$.



*:6800 family or 8080family interface selectable.

6. Timing Characteristics

The RA8835 series is controller IC that can display text and graphics on LCD panel. The RA8835 series can display layered text and graphics, scroll the display in any direction and partition the display into multiple screens. The RA8835 series stores text, character codes and bitmapped graphics data in external frame buffer memory. Display controller functions include transferring data from controlling microprocessor to the buffer memory, reading memory data, converting data to display pixels and generating timing signals for the buffer memory, LCD panel. The RA8835 series has internal character generator with 160, 5*7 pixel characters in internal mask ROM. The character generators support up to 64,8*16 pixel characters in external characters in external character generator RAM and up to 256,8*16 pixel characters in external character generator ROM .

The Command Set

Table 1. Command set

Class	Command	Code												Hex	Command Description	Command Read Parameters	
		RD	WR	A0	D7	D6	D5	D4	D3	D2	D1	D0	No. of Bytes			Section	
System control	SYSTEM SET	1	0	1	0	1	0	0	0	0	0	0	40	Initialize device and display	8	8.2.1	
	SLEEP IN	1	0	1	0	1	0	1	0	0	1	1	53	Enter standby mode	0	8.2.2	
Display control	DISP ON/OFF	1	0	1	0	1	0	1	1	0	0	D	58, 59	Enable and disable display and display flashing	1	8.3.1	
	SCROLL	1	0	1	0	1	0	0	0	1	0	0	44	Set display start address and display regions	10	8.3.2	
	CSRFORM	1	0	1	0	1	0	1	1	1	0	1	5D	Set cursor type	2	8.3.3	
	CGRAM ADR	1	0	1	0	1	0	1	1	1	0	0	5C	Set start address of character generator RAM	2	8.3.6	
	CSRDIR	1	0	1	0	1	0	0	1	1	CD 1	CD 0	4C to 4F	Set direction of cursor movement	0	8.3.4	
	HDOT SCR	1	0	1	0	1	0	1	1	0	1	0	5A	Set horizontal scroll position	1	8.3.7	
	OVLAY	1	0	1	0	1	0	1	1	0	1	1	5B	Set display overlay format	1	8.3.5	
Drawing control	CSRW	1	0	1	0	1	0	0	0	1	1	0	46	Set cursor address	2	8.4.1	
	CSRR	1	0	1	0	1	0	0	0	1	1	1	47	Read cursor address	2	8.4.2	
Memory control	MWRITE	1	0	1	0	1	0	0	0	0	1	0	42	Write to display memory	—	8.5.1	
	MREAD	1	0	1	0	1	0	0	0	0	1	1	43	Read from display memory	—	8.5.2	

Notes:

- In general, the internal registers of the RA8835 series are modified as each command parameter is input. However, the microprocessor does not have to set all the parameters of a command and may send a new command before all parameters have been input. The internal registers for the parameters that have been input will have been changed but the remaining parameter registers are unchanged.
 - 2-byte parameters (where two bytes are treated as 1 data item) are handled as follows:
 - CSRW, CSRR: Each byte is processed individually. The microprocessor may read or write just the low byte of the cursor address.
 - SYSTEM SET, SCROLL, CGRAM ADR: Both parameter bytes are processed together. If the command is changed after half of the parameter has been input, the single byte is ignored.
- APL and APH are 2-byte parameters, but are treated as two 1-byte parameters.

SYSTEM SET

Initializes the device, sets the window sizes, and selects the LCD interface format. Since this command sets the basic operating parameters of the RA8835 i series, an

incorrect SYSTEM SET command may cause other commands to operate incorrectly.

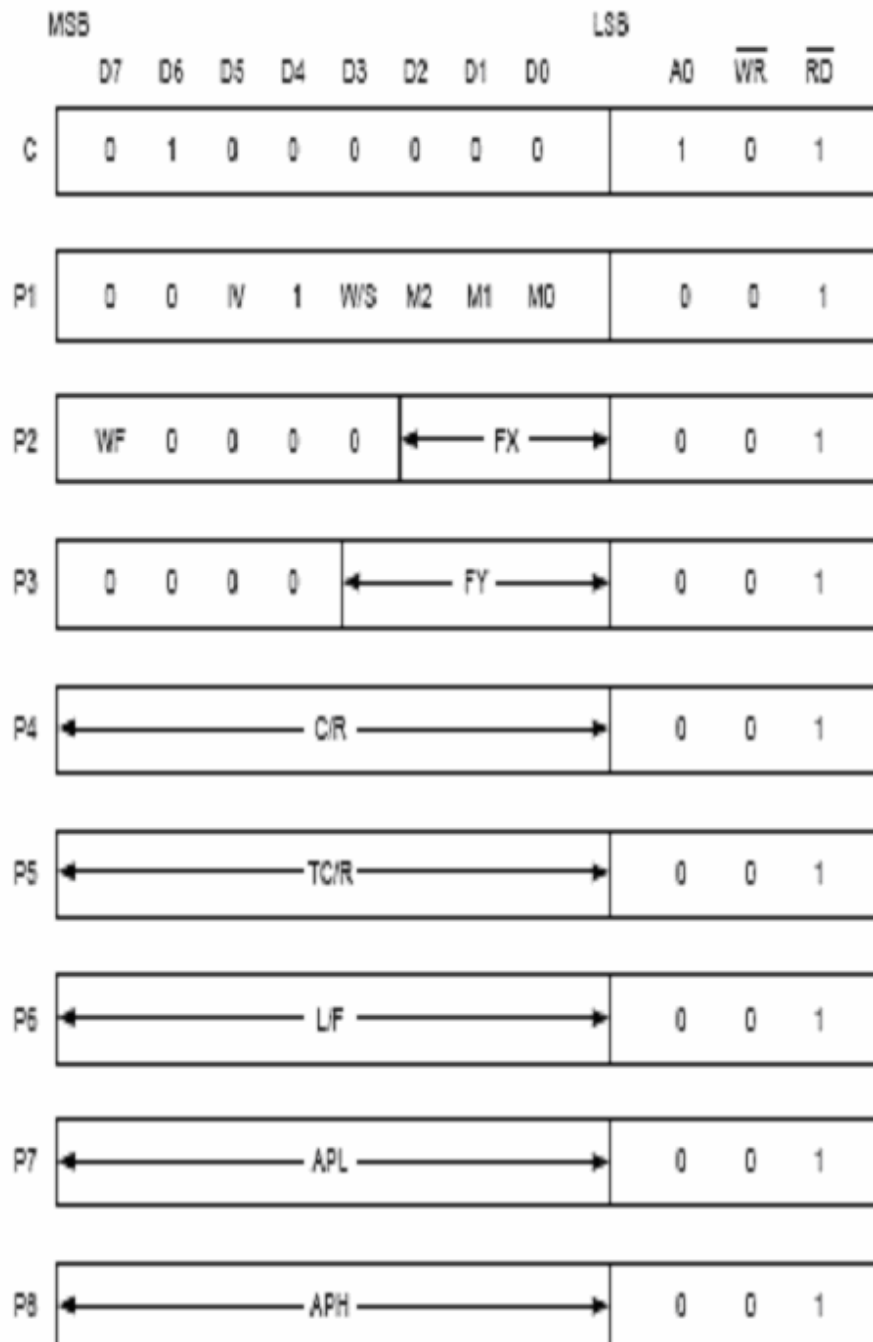


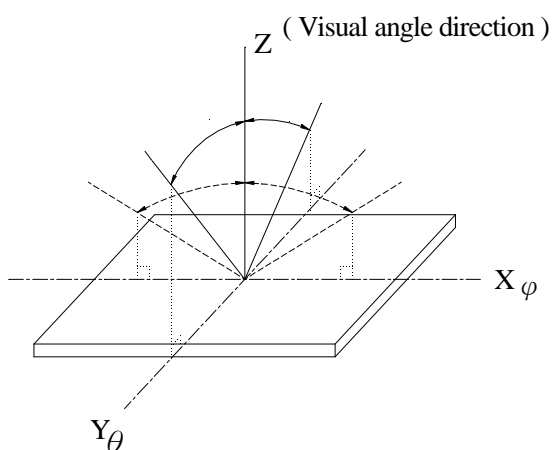
Figure 1. SYSTEM SET instruction

7. Optical Characteristics

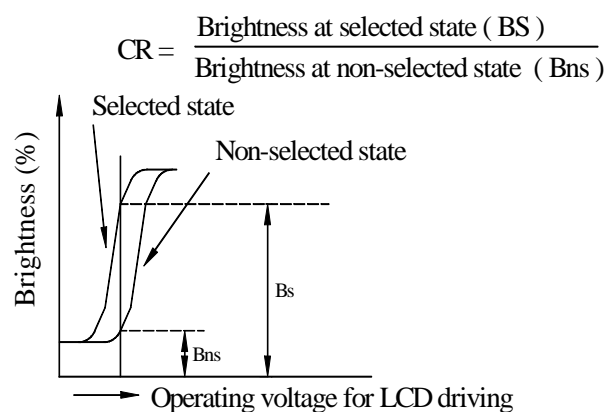
ITEM	SYMBAL	CONDITION	MIN	TYP	MAX	UNIT
View Angle	(V) θ	$CR \geq 2$	20	—	40	deg.
	(H) ϕ	$CR \geq 2$	-30	—	30	deg.
Contrast Ratio	CR	—	—	3	—	—
Response Time	T rise	—	—	200	300	ms
	T fall	—	—	150	200	ms

7.1 Definitions

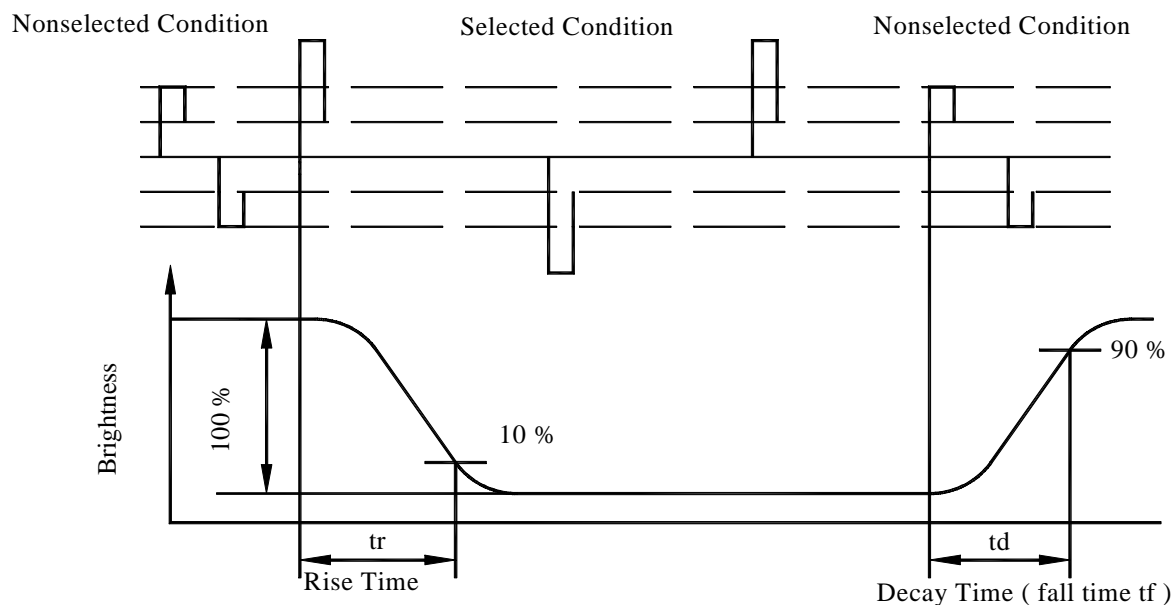
■View Angles



■Contrast Ratio



■Response Time



8. Absolute Maximum Ratings

Item	Symbol	Min	Typ	Max	Unit
Operating Temperature	T_{OP}	-20	—	+70	°C
Storage Temperature	T_{ST}	-30	—	+80	°C
Input Voltage	V_{IN}	-0.3	—	$V_{DD}+0.3$	V
Supply Voltage For Logic	$V_{DD}-V_{SS}$	-0.3	—	7.0	V
Supply Voltage For LCD	$V_{DD}-V_0$	0	—	32	V

9. Electrical Characteristics

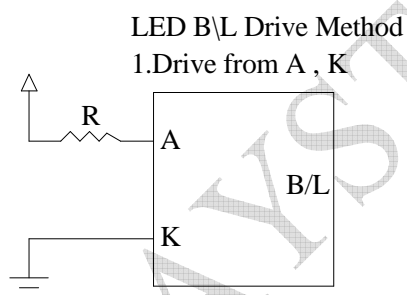
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Logic Voltage	$V_{DD}-V_{SS}$	—	4.5	5.0	5.5	V
Supply Voltage For LCD	$V_{DD}-V_0$	$T_a=-20^{\circ}\text{C}$	—	—	26.2	V
		$T_a=25^{\circ}\text{C}$	23.0	23.6	24.2	V
		$T_a=70^{\circ}\text{C}$	22.1	—	—	V
Input High Volt.	V_{IH}	—	$0.5V_{DD}$	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	VSS	—	$0.2V_{DD}$	V
Output High Volt.	V_{OH}	—	2.4	—	—	V
Output Low Volt.	V_{OL}	—	—	—	0.4	V
Supply Current	I_{DD}	VDD=5.0V	90.0	100.0	110.0	mA

10. Backlight Information

Specification

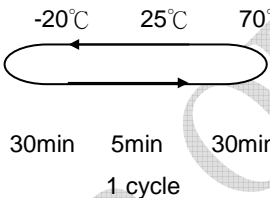
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	I _{LED}	162	180	216	mA	V=4.0V
Supply Voltage	V	3.8	4.0	4.4	V	—
Reverse Voltage	V _R	—	—	10	V	—
Luminance (Without LCD)	I _V	18.4	23	—	CD/M ²	I _{LED} =180mA
Wave Length	λ _p	568	570	574	nm	I _{LED} =180mA
Life Time	—	—	100000	—	Hr.	I _{LED} ≤ 180mA 25°C, 50-60%RH
Color	Yellow Green					

Note: The LED of B/L is drive by current only, drive voltage is for reference only.
drive voltage can make driving current under safety area (current between minimum and maximum).



11. Reliability

Content of Reliability Test (wide temperature, -20℃~70℃)

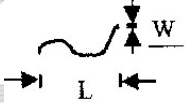
Environmental Test			
Test Item	Content of Test	Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80℃ 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30℃ 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70℃ 200hrs	-
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20℃ 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60℃,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60℃,90%RH 96hrs	1,2
Thermal shock resistance	<p>The sample should be allowed stand the following 10 cycles of operation</p> 	-20℃/70℃ 10 cycles	-
Vibration test	Endurance test applying the vibration during transportation and using.	<p>fixed amplitude: 15mm Vibration. Frequency: 10~55Hz. One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes</p>	3
Static electricity test	Endurance test applying the electric stress to the terminal.	<p>VS=800V,RS= 1.5kΩ CS=100pF 1 time</p>	—

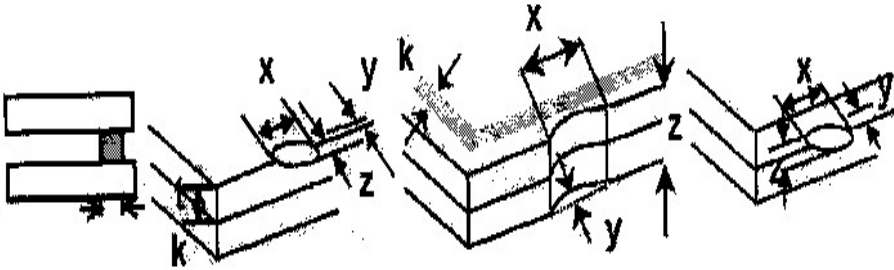
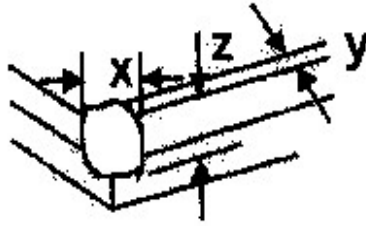
Note1: No dew condensation to be observed.

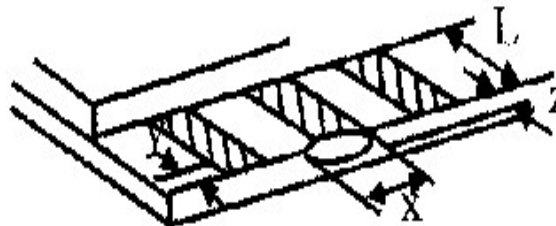
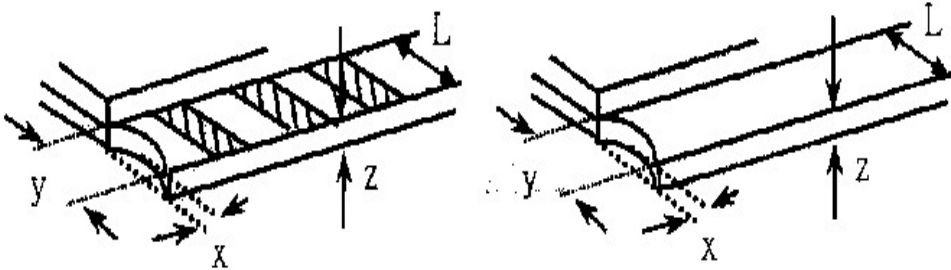
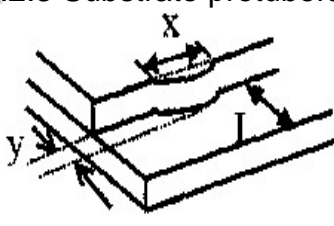
Note2: The function test shall be conducted after 4 hours storage at the normal temperature and humidity after remove from the test chamber.

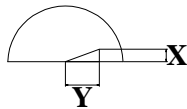
Note3: The packing have to including into the vibration testing.

12. Inspection specification

NO	Item	Criterion	AQL												
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65												
02	Black or white spots on LCD (display only)	2.1 White and black spots on display 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm	2.5												
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type : As following drawing $\Phi = (x + y) / 2$	2.5												
		3.2 Line type : (As following drawing)  <table><tr><th>Length</th><th>Width</th><th>Acceptable QTY</th></tr><tr><td>---</td><td>W 0.02</td><td>Accept no dense</td></tr><tr><td>L 3.0</td><td>0.02 W 0.03</td><td rowspan="2">2</td></tr><tr><td>L 2.5</td><td>0.03 W 0.05</td></tr><tr><td>---</td><td>0.05 W</td><td>As round type</td></tr></table>	Length	Width	Acceptable QTY	---	W 0.02	Accept no dense	L 3.0	0.02 W 0.03	2	L 2.5	0.03 W 0.05	---	0.05 W
Length	Width	Acceptable QTY													
---	W 0.02	Accept no dense													
L 3.0	0.02 W 0.03	2													
L 2.5	0.03 W 0.05														
---	0.05 W	As round type													
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction. <table><tr><th>Size Φ</th><th>Acceptable QTY</th></tr><tr><td>Φ 0.20</td><td>Accept no dense</td></tr><tr><td>0.20 Φ 0.50</td><td>3</td></tr><tr><td>0.50 Φ 1.00</td><td>2</td></tr><tr><td>1.00 Φ</td><td>0</td></tr><tr><td>Total QTY</td><td>3</td></tr></table>	Size Φ	Acceptable QTY	Φ 0.20	Accept no dense	0.20 Φ 0.50	3	0.50 Φ 1.00	2	1.00 Φ	0	Total QTY	3	2.5
Size Φ	Acceptable QTY														
Φ 0.20	Accept no dense														
0.20 Φ 0.50	3														
0.50 Φ 1.00	2														
1.00 Φ	0														
Total QTY	3														

NO	Item	Criterion	AQL																		
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination																			
06	Chipped glass	<p>Symbols Define: x: Chip length y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length:</p> <p>6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td>Z 1/2t</td><td>Not over viewing area</td><td>x 1/8a</td></tr><tr><td>1/2t z 2t</td><td>Not exceed 1/3k</td><td>x 1/8a</td></tr></table> <p>If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td>Z 1/2t</td><td>Not over viewing area</td><td>x 1/8a</td></tr><tr><td>1/2t z 2t</td><td>Not exceed 1/3k</td><td>x 1/8a</td></tr></table> <p>If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	Z 1/2t	Not over viewing area	x 1/8a	1/2t z 2t	Not exceed 1/3k	x 1/8a	z: Chip thickness	y: Chip width	x: Chip length	Z 1/2t	Not over viewing area	x 1/8a	1/2t z 2t	Not exceed 1/3k	x 1/8a	2.5
		z: Chip thickness	y: Chip width	x: Chip length																	
Z 1/2t	Not over viewing area	x 1/8a																			
1/2t z 2t	Not exceed 1/3k	x 1/8a																			
z: Chip thickness	y: Chip width	x: Chip length																			
Z 1/2t	Not over viewing area	x 1/8a																			
1/2t z 2t	Not exceed 1/3k	x 1/8a																			

NO	Item	Criterion	AQL						
06	Glass crack	<p>Symbols :</p> <p>x: Chip length y: Chip width z: Chip thickness</p> <p>k: Seal width t: Glass thickness a: LCD side length</p> <p>L: Electrode pad length</p> <p>6.2 Protrusion over terminal :</p> <p>6.2.1 Chip on electrode pad :</p>	2.5						
									
		<table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td>y 0.5mm</td><td>x 1/8a</td><td>0 z t</td></tr></table>		y: Chip width	x: Chip length	z: Chip thickness	y 0.5mm	x 1/8a	0 z t
		y: Chip width		x: Chip length	z: Chip thickness				
y 0.5mm	x 1/8a	0 z t							
<p>6.2.2 Non-conductive portion:</p> 									
		<table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td>y L</td><td>x 1/8a</td><td>0 z t</td></tr></table> <p>If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</p> <p>If the product will be heat sealed by the customer, the alignment mark not be damaged.</p> <p>6.2.3 Substrate protuberance and internal crack.</p> 	y: Chip width	x: Chip length	z: Chip thickness	y L	x 1/8a	0 z t	
y: Chip width	x: Chip length	z: Chip thickness							
y L	x 1/8a	0 z t							
		<table><tr><td>y: width</td><td>x: length</td></tr><tr><td>y 1/3L</td><td>x a</td></tr></table>	y: width	x: length	y 1/3L	x a			
y: width	x: length								
y 1/3L	x a								

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down. 10.9 The Scraping testing standard for Copper Coating of PCB  $X * Y \leq 2\text{mm}^2$	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5 2.5
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever.	2.5
		12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging specification sheet.	0.65
		12.11 Product dimension and structure must conform to product specification sheet.	

13. Precautions in use of LCD Modules

1. Avoid applying excessive shocks to the module or making any alterations or modifications to it.
2. Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
3. Don't disassemble the LCM.
4. Don't operate it above the absolute maximum rating.
5. Don't drop, bend or twist LCM.
6. Soldering: only to the I/O terminals.
7. Storage: please storage in anti-static electricity container and clean environment.
8. Raystar have the right to change the passive components
(Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
9. Raystar have the right to change the PCB Rev.

14. Material List of Components for RoHs

1. RAYSTAR Optronics Co., Ltd. hereby declares that all of or part of products, including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm
Above limited value is set up according to RoHS.						

2. Process for RoHS requirement :

- (1) Use the Sn/Ag/Cu soldering surface the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :
 Reflow : 250°C , 30 seconds Max.
 Connector soldering wave or hand soldering : 320°C , 10 seconds max.
- (3) Temp. curve of reflow, max. Temp. : 235±5°C
 Recommended customer's soldering temp. of connector : 280°C , 3 seconds.

15. Recommendable storage

1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
2. Do not place the module near organics solvents or corrosive gases.
3. Do not crush, shake, or jolt the module

LCM Sample Estimate Feedback Sheet

Module Number : _____

1 Panel Specification :

1. Panel Type :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
2. View Direction :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
3. Numbers of Dots :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
4. View Area :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
5. Active Area :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
6. Operating Temperature :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
7. Storage Temperature :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
8. Others :	_____	

2 Mechanical Specification :

1. PCB Size :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
2. Frame Size :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
3. Material of Frame :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
4. Connector Position :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
5. Fix Hole Position :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
6. Backlight Position :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
7. Thickness of PCB :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
8. Height of Frame to PCB :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
9. Height of Module :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
10. Others :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____

3 Relative Hole Size :

1. Pitch of Connector :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
2. Hole size of Connector :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
3. Mounting Hole size :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
4. Mounting Hole Type :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
5. Others :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____

4 Backlight Specification :

1. B/L Type :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
2. B/L Color :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
3. B/L Driving Voltage (Reference for LED Type) :	<input type="checkbox"/> Pass <input type="checkbox"/> NG , _____	
4. B/L Driving Current :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
5. Brightness of B/L :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
6. B/L Solder Method :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
7. Others :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____

Go to page 2

Module Number : _____

5 Electronic Characteristics of Module :

1.Input Voltage :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
2.Supply Current :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
3.Driving Voltage for LCD :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
4.Contrast for LCD :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
5.B/L Driving Method :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
6.Negative Voltage Output :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
7.Interface Function :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
8.LCD Uniformity :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
9.ESD test :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____
10.Others :	<input type="checkbox"/> Pass	<input type="checkbox"/> NG , _____

6 Summary :
Sales signature : _____

Customer Signature : _____

Date : / /